DATA SHEET

74LVT245B

3.3V Octal transceiver with direction pin (3-State)

Product specification

1999 Mar 19

IC23 Data Handbook





3.3V Octal transceiver with direction pin (3-State)

74LVT245B

FEATURES

- Octal bidirectional bus interface
- 3-State buffers
- Output capability: +64mA/-32mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power-up 3-State
- No bus current loading when output is tied to 5V bus
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

DESCRIPTION

The LVT245B is a high-performance BiCMOS product designed for $V_{\rm CC}$ operation at 3.3V.

This device is an octal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features an Output Enable (\overline{OE}) input for easy cascading and a Direction (DIR) input for direction control.

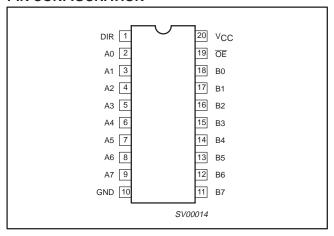
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Bn or Bn to An	$C_L = 50pF;$ $V_{CC} = 3.3V$	2.4	ns
C _{IN}	Input capacitance DIR, OE	V _I = 0V or 3.0V	4	pF
C _{I/O}	I/O pin capacitance	Outputs disabled; V _{I/O} = 0V or 3.0V	10	pF
I _{CCZ}	Total supply current	Outputs disabled; V _{CC} = 3.6V	0.13	mA

ORDERING INFORMATION

STEP ET STEP STEP STEP STEP STEP STEP ST			
PACKAGES	TEMPERATURE RANGE	ORDERING INFORMATION	DWG NUMBER
20-Pin Plastic SO	−40°C to +85°C	74LVT245B D	SOT163-1
20-Pin Plastic SSOP	−40°C to +85°C	74LVT245B DB	SOT339-1
20-Pin Plastic TSSOP	-40°C to +85°C	74LVT245B PW	SOT360-1

PIN CONFIGURATION



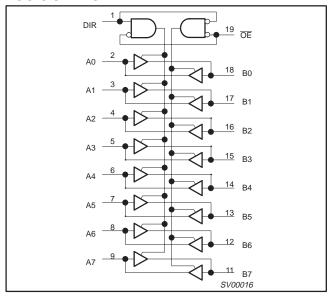
PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	DIR	Direction control input
2, 3, 4, 5, 6, 7, 8, 9	A0 – A7	Data inputs/outputs (A side)
18, 17, 16, 15, 14, 13, 12, 11	B0 – B7	Data inputs/outputs (B side)
19	ŌĒ	Output enable input (active–Low)
10	GND	Ground (0V)
20	V _{CC}	Positive supply voltage

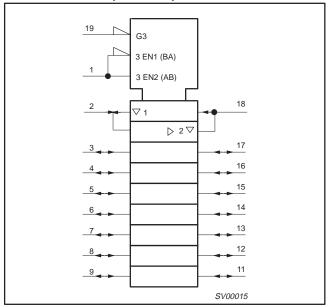
3.3V Octal transceiver with direction pin (3-State)

74LVT245B

LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

INP	UTS	INPUTS/0	OUTPUTS
<u>OE</u> n	DIR	An	Bn
L	L	An= Bn	Inputs
L	Н	Inputs	Bn =An
Н	Х	Z	Z

H = High voltage level

L = Low voltage level

X = Don't care

Z = High impedance "Off" state

ABSOLUTE MAXIMUM RATINGS^{1,2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V _I < 0	-50	mA
VI	DC input voltage ³		−0.5 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +7.0	V
	DC submit surrout	Output in Low state	128	A
IOUT	DC output current	Output in High state	-64	mA
T _{stg}	Storage temperature range		-65 to +150	°C

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

3.3V Octal transceiver with direction pin (3-State)

74LVT245B

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STWIBOL	FARAMETER	MIN	MAX	ONIT
V _{CC}	DC supply voltage	2.7	3.6	V
V _I	Input voltage	0	5.5	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Input voltage		0.8	V
I _{OH}	High-level output current		-32	mA
la.	Low-level output current		32	mA
lor	Low-level output current; current duty cycle ≤ 50%; f ≥ 1kHz		64	ША
Dt/Dv	Input transition rise or fall rate; Outputs enabled		10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

					LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS		Temp =	+85°C	UNIT	
				MIN	TYP ¹	MAX	1
V _{IK}	Input clamp voltage	$V_{CC} = 2.7V; I_{IK} = -18mA$			-0.9	-1.2	V
		$V_{CC} = 2.7 \text{ to } 3.6 \text{V}; I_{OH} = -100 \mu\text{A}$		V _{CC} -0.2	V _{CC} -0.1		
V_{OH}	High-level output voltage	$V_{CC} = 2.7V; I_{OH} = -8mA$		2.4	2.5		V
		$V_{CC} = 3.0V; I_{OH} = -32mA$		2.0	2.2		
		$V_{CC} = 2.7V; I_{OL} = 100\mu A$			0.1	0.2	
		V _{CC} = 2.7V; I _{OL} = 24mA			0.3	0.5	1
V_{OL}	Low-level output voltage	V _{CC} = 3.0V; I _{OL} = 16mA			0.25	0.4	V
		$V_{CC} = 3.0V; I_{OL} = 32mA$		i i	0.3	0.5	1
		$V_{CC} = 3.0V; I_{OL} = 64mA$			0.4	0.55	
		$V_{CC} = 0 \text{ or } 3.6V; V_{I} = 5.5V$	Control mino		1	10	
		$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND	Control pins		±0.1	±1	
II	Input leakage current	V _{CC} = 3.6V; V _I = 5.5V			1	20	μΑ
		$V_{CC} = 3.6V; V_I = V_{CC}$	I/O Data pins ⁴		0.1	1	
		$V_{CC} = 3.6V; V_{I} = 0$	1		-1	-5	
I _{OFF}	Output off current	$V_{CC} = 0V; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5V$	•		1	±100	μА
		$V_{CC} = 3V; V_{I} = 0.8V$		75	150		
I_{HOLD}	Bus Hold current A inputs ⁵	$V_{CC} = 3V; V_{I} = 2.0V$		-75	-150		μΑ
		$V_{CC} = 0V \text{ to } 3.6V; V_{CC} = 3.6V$		±500			
I _{EX}	Current into an ouptut in the High state when V _O > V _{CC}	V _O = 5.5V; V _{CC} = 3.0V			60	125	μА
I _{PU/PD}	Power up/down 3-State output current ³	$V_{CC} \le 1.2V$; $V_O = 0.5V$ to V_{CC} ; $V_I = GNIOE/OE$ = Don't care	D or V _{CC} ;		15	±100	μА
Іссн		$V_{CC} = 3.6V$; Outputs High, $V_I = GND$ or		0.13	0.19		
I _{CCL}	Quiescent supply current	$V_{CC} = 3.6V$; Outputs Low, $V_I = GND$ or		3	12	mA	
I _{CCZ}	1	V _{CC} = 3.6V; Outputs Disabled; V _I = GNI		0.13	0.19		
Δl _{CC}	Additional supply current per input pin ²	V_{CC} = 3V to 3.6V; One input at V_{CC} -0.6 Other inputs at V_{CC} or GND	V,		0.1	0.2	mA

NOTES:

- All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.
 This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND
 This parameter is valid for any V_{CC} between 0V and 1.2V with a transition time of up to 10msec. From V_{CC} = 1.2V to V_{CC} = 3.3V ± 0.3V a transition time of 100 μ sec is permitted. This parameter is valid for $T_{amb} = +25$ °C only.

4. Unused pins at V_{CC} or GND.

5. This is the bus hold overdrive current required to force the input to the opposite logic state.

3.3V Octal transceiver with direction pin (3-State)

74LVT245B

AC CHARACTERISTICS

GND = 0V; t_R = t_F = 2.5ns; C_L = 50pF; R_L = 500 Ω ; T_{amb} = -40°C to +85°C.

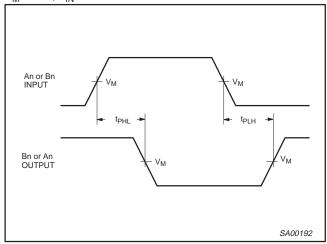
SYMBOL	PARAMETER WAVEFORM		Vco	c = 3.3V +0	V _{CC} = 2.7V	UNIT	
			MIN	TYP ¹	MAX	MAX	
t _{PLH}	Propagation delay An to Bn or Bn to An	1	1.2 1.2	2.4 2.4	3.5 3.5	4.0 4.0	ns
^t PZH t _{PZL}	Output enable time to High and Low level	2	1.3 1.7	3.3 3.2	5.5 5.5	7.1 6.5	ns
t _{PHZ}	Output disable time from High and Low Level	2	2.2 2.2	3.6 3.4	5.9 5.0	6.5 5.1	ns

NOTES:

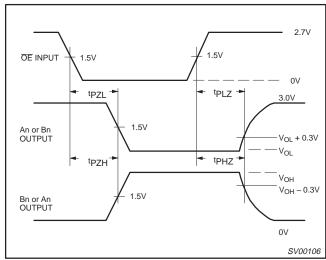
1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to 2.7V



Waveform 1. Input (An or Bn) to Output (Bn or An) Propagation Delays



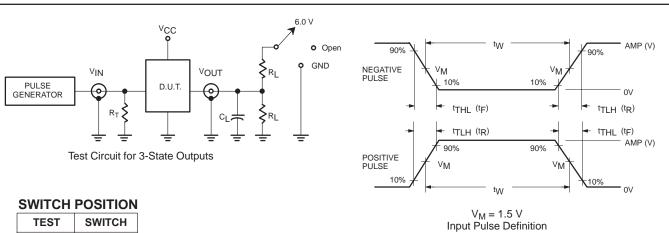
Waveform 2. 3-State Output Enable and Disable Times

1999 Mar 19 5

3.3V Octal transceiver with direction pin (3-State)

74LVT245B

TEST CIRCUIT AND WAVEFORMS



TEST	SWITCH
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	6V
t _{PHZ} /t _{PZH}	GND

DEFINITIONS

 R_L = Load resistor; see AC CHARACTERISTICS for value.

 C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

FAMILY	IN	PUT PULSE R	EQUIRE	MENTS	
FAMILI	Amplitude	Rep. Rate	t _W	t _R	t _F
74LVT	2.7 V	≤10 MHz	500 ns	≤2.5 ns	≤2.5 ns

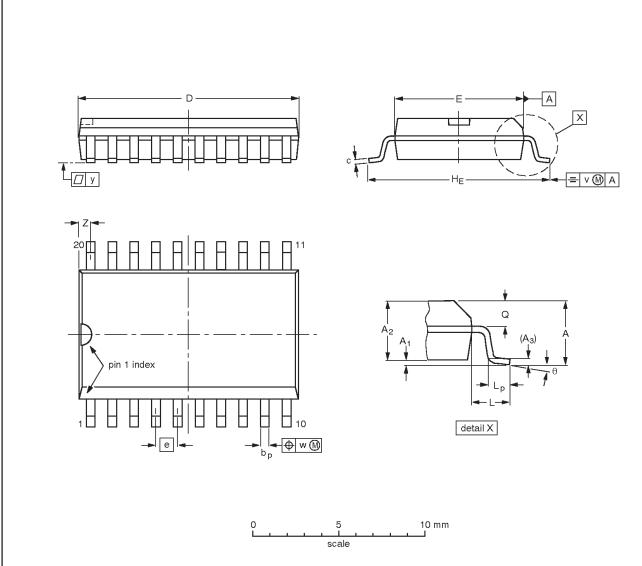
SV00092

3.3V Octal transceiver with direction pin (3-State)

74LVT245B

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	А3	bр	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016		0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFERENCES			EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC				-95-01-24 97-05-22

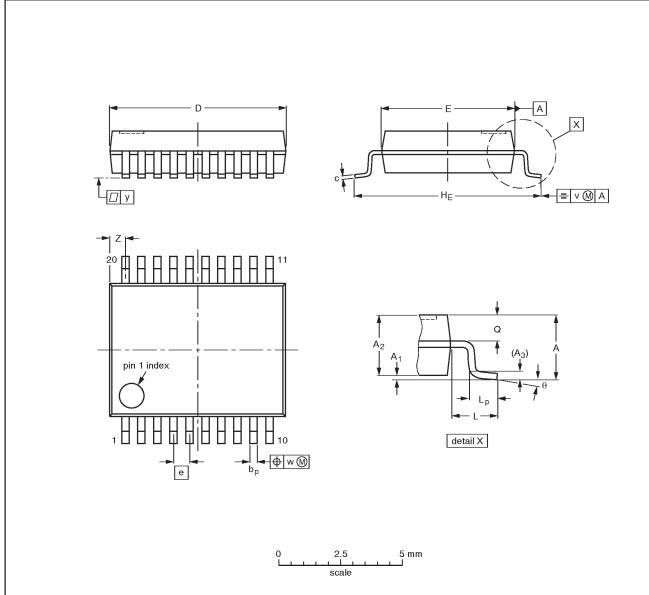
1999 Mar 19 7

3.3V Octal transceiver with direction pin (3-State)

74LVT245B

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bр	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Ø	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

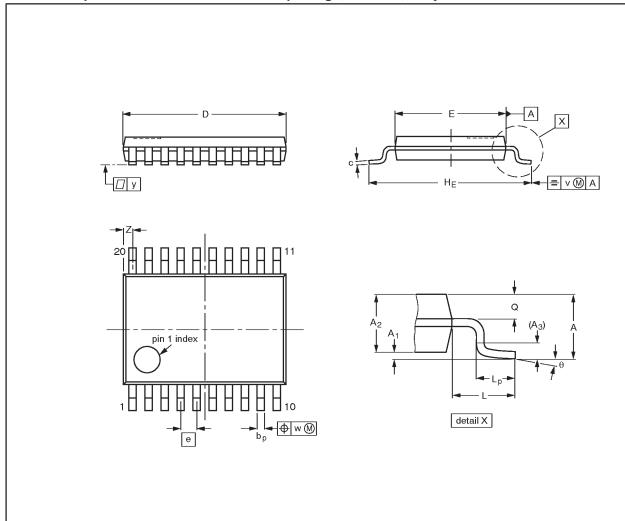
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT339-1		MO-150AE			-93-09-08 95-02-04	

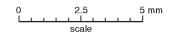
3.3V Octal transceiver with direction pin (3-State)

74LVT245B

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1





DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	рb	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUEDATE
SOT360-1		MO-153AC			-93-06-16- 95-02-04

3.3V Octal transceiver with direction pin (3-State)

74LVT245B

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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